

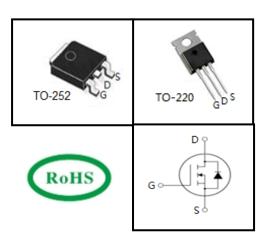
40V N-Channel Trench MOSFET

FEATURES

- Trench Power MOSFET Technology
- Low R_{DS(ON)}
- Low Gate Charge
- Optimized For Fast-switching Applications

APPLICATIONS

- Synchronous Rectification in DC/DC and AC/DC Converters
- Isolated DC/DC Converters in Telecom and Industrial



Device Marking and Package Information			
Device Package Marking			
TTD70N04AT	TO-252	70N04AT	
TTP70N04AT	TO-220	70N04AT	

Absolute Maximum Ratings $T_c = 25^{\circ}C$, unless otherwise noted				
Parameter	Symbol	Value		11
Farameter	Symbol	TO-252	TO-220	Unit
Drain-Source Voltage ($V_{GS} = 0V$)	V _{DSS}	4	0	V
Continuous Drain Current	۱ _D	70		A
Pulsed Drain Current (note1)	I _{DM}	280		A
Gate-Source Voltage	V _{GSS}	±	20	V
Single Pulse Avalanche Energy (note2)	E _{AS}	66.2		mJ
Avalanche Current	I _{As}	21		A
Power Dissipation (T _C = 25°C)	P _D	108		W
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55~	+175	°C

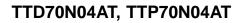
Thermal Resistance				
Parameter	Symbol	Va	11	
		TO-252	TO-220	Unit
Thermal Resistance, Junction-to-Case R _{thJC} 1.38		38		
Thermal Resistance, Junction-to-Ambient	R _{thJA}	6	0	K/W

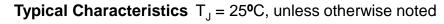


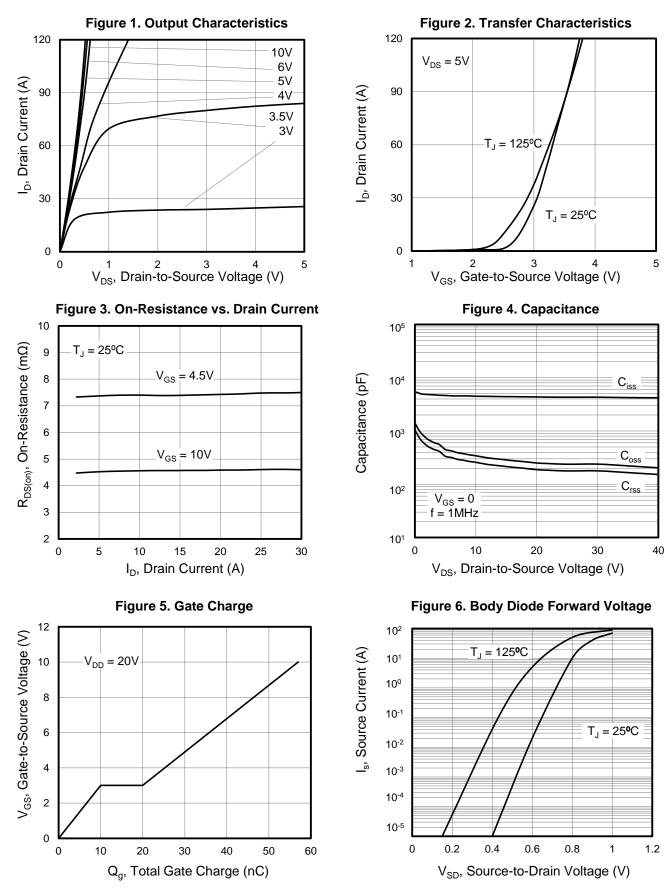
Specifications $T_J = 25^{\circ}C$, ur	less othe	rwise noted				
Parameter	Symbol	Test Conditions	Value			11
		Test conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0V, I_{D} = 250 \mu A$	40			V
Zara Cata Valtaga Drain Currant		$V_{DS} = 40V, V_{GS} = 0V, T_{J} = 25^{\circ}C$			1	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 40V, V_{GS} = 0V, T_{J} = 150^{\circ}C$			100	μA
Gate-Source Leakage	I _{GSS}	V_{GS} = $\pm 20V$			±100	nA
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.0	1.7	2.4	V
	5	V _{GS} = 10V, I _D = 30A		4.5	6.4	mΩ
Drain-Source On-Resistance (Note3)	R _{DS(on)}	$V_{GS} = 4.5 V, I_{D} = 30 A$		7.1	9.4	mΩ
Forward Transconductance (Note3)	g _{fs}	V _{DS} = 10V, I _D =20A		33		S
Dynamic						
Input Capacitance	C _{iss}	\/0\/		4355		
Output Capacitance	C _{oss}	$V_{GS} = 0V,$ $V_{DS} = 20V,$		251		pF
Reverse Transfer Capacitance	C _{rss}	f = 1.0MHz		188		
Total Gate Charge	Qg			57		
Gate-Source Charge	Q _{gs}	$V_{DD} = 20V, I_D = 20A,$ $V_{GS} = 10V$		10		nC
Gate-Drain Charge	Q_{gd}	65		10		
Turn-on Delay Time	t _{d(on)}			7		
Turn-on Rise Time	t _r	V _{DD} = 20V, I _D = 20A,		4		
Turn-off Delay Time	t _{d(off)}	$R_{\rm G} = 3\Omega$		25		ns
Turn-off Fall Time	t _f			5		
Drain-Source Body Diode Characteris	stics					
Continuous Body Diode Current	۱ _s	T _C = 25°C			70	۸
Pulsed Diode Forward Current	I _{SM}				280	A
Body Diode Voltage	V _{SD}	$T_J = 25^{\circ}C, I_{SD} = 20A, V_{GS} = 0V$			1.2	V
Reverse Recovery Time	t _{rr}	I _F = 20A,		15.5		ns
Reverse Recovery Charge	Q _{rr}	$di_F/dt = 100A/\mu s$		31		nC

Notes

- 1. Repetitive Rating: Pulse Width limited by maximum junction temperature
- 2. $V_{DD} = 40V$, $R_G = 25\Omega$, Starting $T_J = 25^{\circ}C$
- 3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 1%







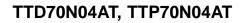
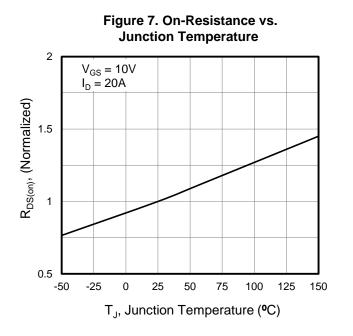
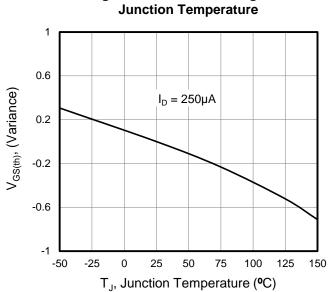


Figure 8. Threshold Voltage vs.

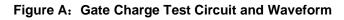


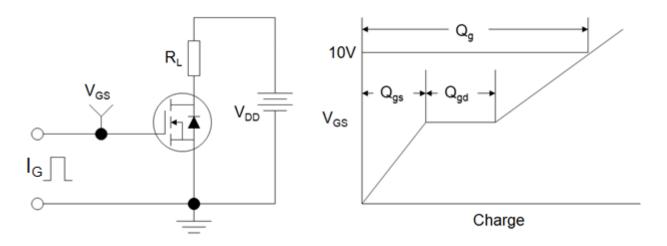
Typical Characteristics $T_J = 25^{\circ}C$, unless otherwise noted

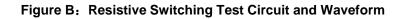


10¹ Z_{thJC}, Thermal Impedance (Normalized) 10⁰ D = 0.5 10⁻¹ D = 0.2 D = 0.1 D = 0.05 10⁻² D = 0.02D = 0.01 Single Pulse 10-3 10-4 10⁻² 10-6 10-5 10⁻³ 10-1 T_p , Pulse Width (s)

Figure 9. Transient Thermal Impedance







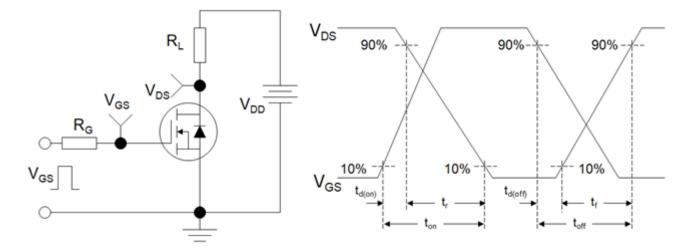
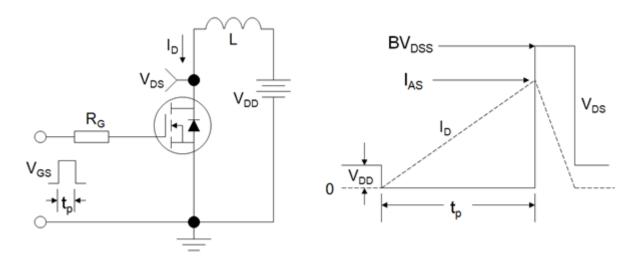
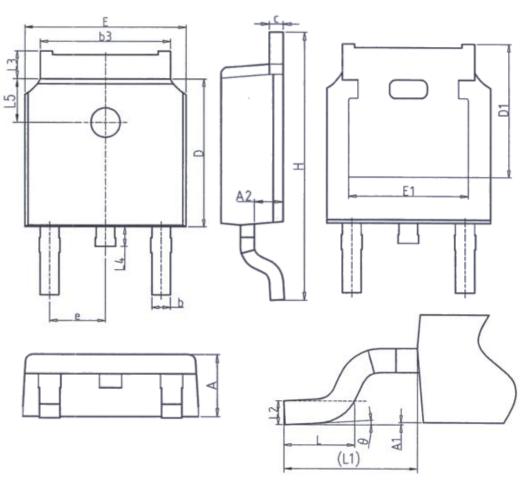


Figure C: Unclamped Inductive Switching Test Circuit and Waveform





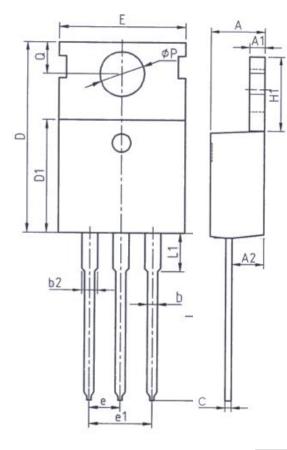
TO-252

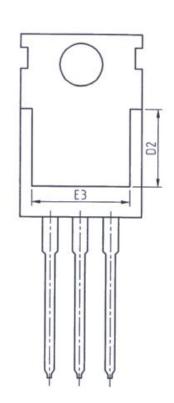


Unit: mm			
Symbol	Min.	Max.	
Α	2.20	2.40	
A1	0.00	0.20	
A2	0.97	1.17	
b	0.68	0.90	
b3	5.20	5.50	
с	0.43	0.63	
D	5.98	6. 22	
D1	D1 5. 30REF		
E	6.40	6.80	
E1	4.63	-	

Unit: mm				
Symbol	Min. Max.			
е	2. 286BSC			
Н	9.40 10.50			
L	1.38 1.75			
L1	2. 90REF			
L2	0. 51BSC			
L3	0.88 1.28			
L4	- 1.00			
L5	1.65 1.95			
θ	0°	8°		

TO-220





Unit: mm			
Symbol	Min.	Max.	
Α	4.37	4.77	
A1	1.25	1.45	
A2	2.20	2.60	
b	0.70	0.95	
b2	1.17	1.47	
С	0.40	0.65	
D	15.10	16. 10	
D1	8.80	9.40	
D2	5.50	-	

Unit: mm			
Symbol	Min. Max.		
E	9.70	10. 30	
E3	7.00 -		
e	2. 54BSC		
e1	5. 08BSC		
H1	6.25	6.85	
L	12.75 13.80		
L1	- 3.40		
Р	3.40 3.80		
Q	2.60	3.00	



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